

Triac Low Power Use

> REJ03G0301-0200 Rev.2.00 Nov.08.2004

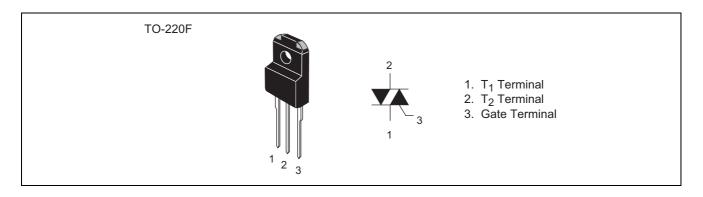
Features

- $I_{T(RMS)}: 3 A$
- V_{DRM} : 600 V
- $I_{\text{FGTI}}^{\text{om}}$, I_{RGTI} , I_{RGT} : 20 mA (10 mA)^{Note5}
- Viso : 2000 V

Outline

- Insulated Type
- Planar Passivation Type
- UL Recognized : Yellow Card No. E223904

File No. E80271



Applications

Contactless AC switch, light dimmer, electric blanket, control of household equipment such as electric fan, solenoid driver, small motor control, and other general purpose control applications

Maximum Ratings

Parameter	Symbol	Voltage class	Unit	
Falanietei	Symbol	12		
Repetitive peak off-state voltage ^{Note1}	V _{DRM}	600	V	
Non-repetitive peak off-state voltage ^{Note1}	V _{DSM}	720	V	

BCR3PM-12L

Parameter	Symbol	Ratings	Unit	ConditionsCommercial frequency, sine full wave360° conduction, Tc = 107°C	
RMS on-state current	I _{T (RMS)}	3.0	A		
Surge on-state current	I _{TSM}	30	A	60Hz sinewave 1 full cycle, peak value, non-repetitive	
I ² t for fusing	l ² t	3.7	A ² s	Value corresponding to 1 cycle of half wave 60Hz, surge on-state current	
Peak gate power dissipation	P _{GM}	3	W		
Average gate power dissipation	P _{G (AV)}	0.3	W		
Peak gate voltage	V _{GM}	6	V		
Peak gate current	I _{GM}	0.5	А		
Junction temperature	Tj	- 40 to +125	°C		
Storage temperature	Tstg	- 40 to +125	°C		
Massim	—	2.0	g	Typical value	
Isolation voltage	Viso	2000	V	Ta = 25°C, AC 1 minute, T ₁ ·T ₂ ·G terminal to case	

Notes: 1. Gate open.

Electrical Characteristics

Parameter		Symbol	Min.	Тур.	Max.	Unit	Test conditions
Repetitive peak off-state cur	rent	I _{DRM}	_	—	2.0	mA	Tj = 125°C, V _{DRM} applied
On-state voltage		V _{TM}		—	1.5	V	$Tc = 25^{\circ}C, I_{TM} = 4.5 A,$
							Instantaneous measurement
Gate trigger voltage ^{Note2}	Ι	V_{FGTI}		_	1.5	V	$Tj = 25^{\circ}C, V_D = 6 V, R_L = 6 \Omega,$
	II	V _{RGTI}		_	1.5	V	R _G = 330 Ω
	III	V _{RGTIII}		—	1.5	V	
Gate trigger current ^{Note2}	Ι	I _{FGTI}		—	20 ^{Note5}	mA	$Tj=25^{\circ}C,\ V_{D}=6\ V,\ R_{L}=6\ \Omega,$
	II	I _{RGTI}		_	20 ^{Note5}	mA	R _G = 330 Ω
	III	I _{RGTIII}		—	20 ^{Note5}	mA	
Gate non-trigger voltage		V _{GD}	0.2	—	—	V	$Tj = 125^{\circ}C, V_D = 1/2 V_{DRM}$
Thermal resistance		R _{th (j-c)}	_	—	4.5	°C/W	Junction to case ^{Note3}
Critical-rate of rise of off-stat	e	(dv/dt)c	5	_	—	V/µs	Tj = 125°C
commutating voltage ^{Note4}							

Notes: 2. Measurement using the gate trigger characteristics measurement circuit.

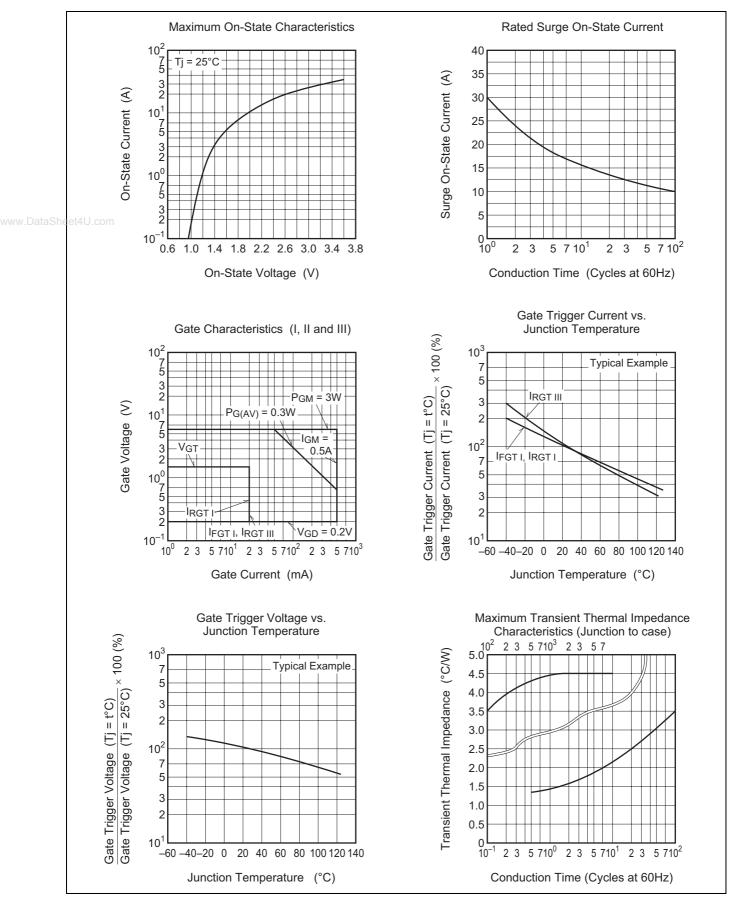
3. The contact thermal resistance $R_{th\,(c\text{-}f)}$ in case of greasing is 0.5°C/W.

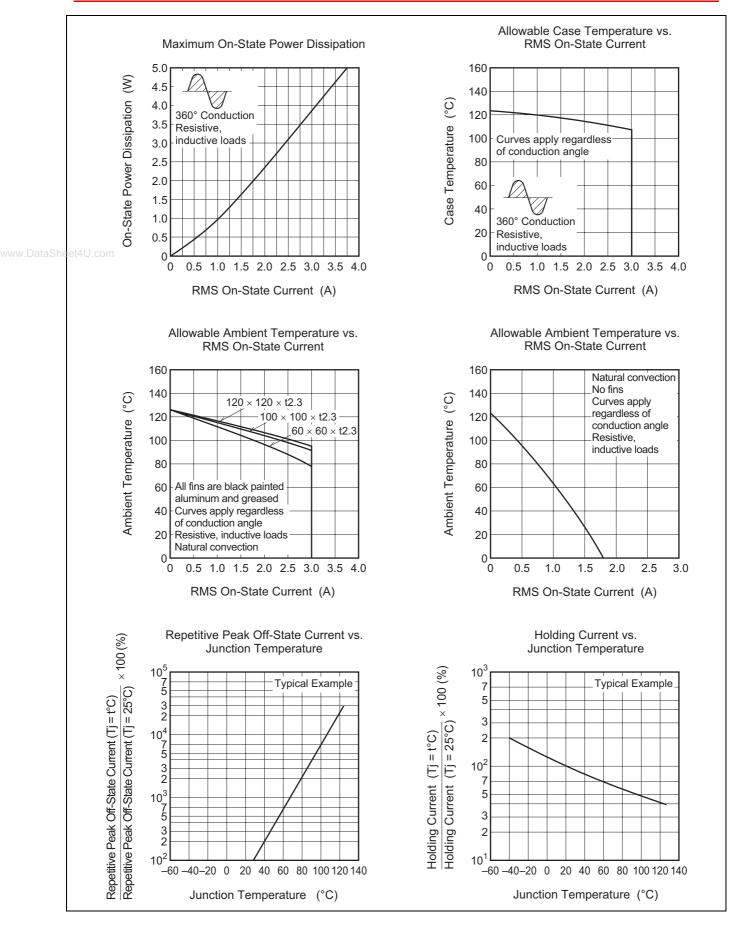
4. Test conditions of the critical-rate of rise of off-state commutating voltage is shown in the table below.

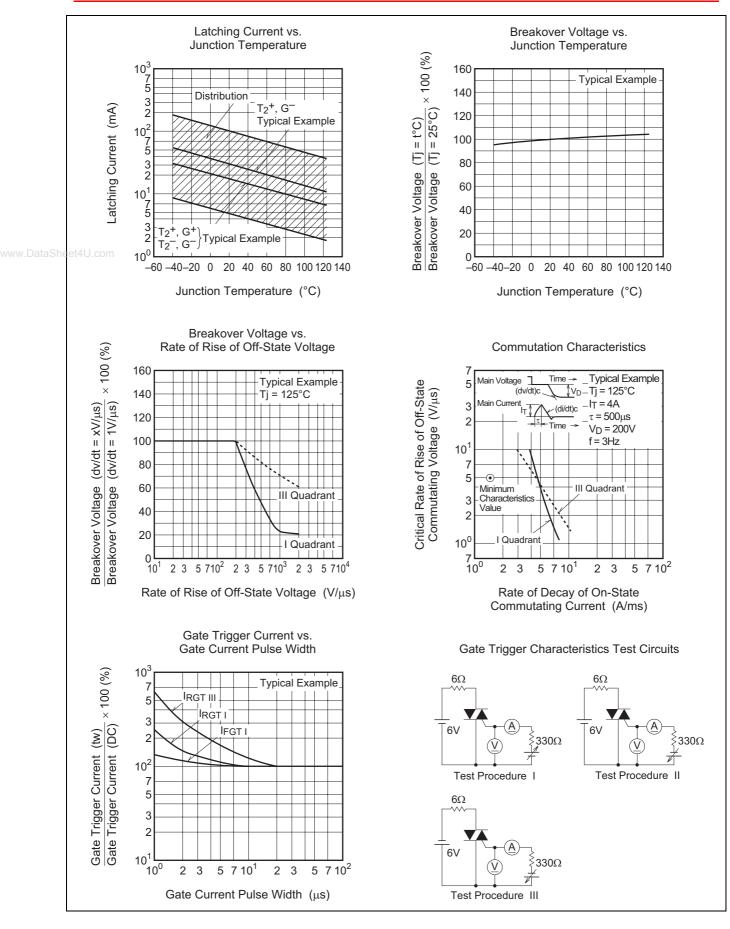
5. High sensitivity ($I_{GT} \le 10$ mA) is also available. (I_{GT} item: 1)

Test conditions	Commutating voltage and current waveforms (inductive load)		
1. Junction temperature Tj = 125°C	Supply Voltage → Time		
 Rate of decay of on-state commutating current (di/dt)c = -1.5 A/ms 	Main Current → Time		
3. Peak off-state voltage $V_D = 400 \text{ V}$	Main Voltage → Time (dv/dt)c V _D		

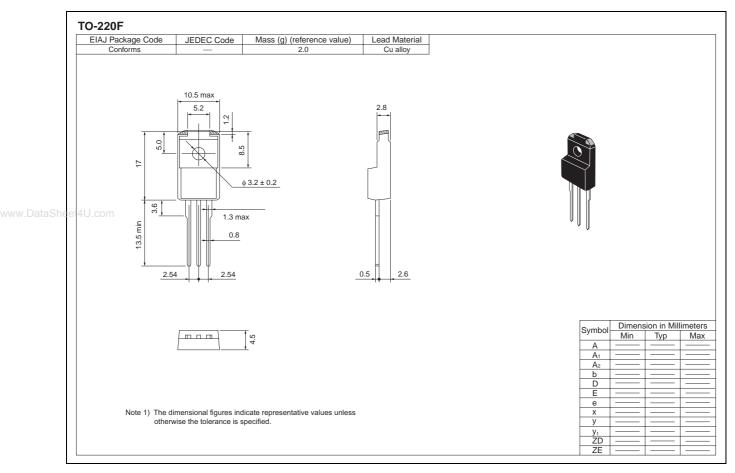
Performance Curves







Package Dimensions



Order Code

Standard packing	Quantity	Standard order code	Standard order code example
Vinyl sack	100	Type name +A	BCR3PM-12LA
Plastic Magazine (Tube)	50	Type name +A – Lead forming code	BCR3PM-12LA-A8
	/inyl sack	/inyl sack 100	/inyl sack 100 Type name +A

Note : Please confirm the specification about the shipping in detail.

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